Chip Monolithic Ceramic Capacitor Bonding Type for General GMD033R60J104KE11_ (0201, X5R:EIA, 0.1uF, DC6.3V)

_: packaging code

Reference Sheet

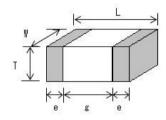
1.Scope

This product specification is applied to Chip Monolithic Ceramic Capacitor Bonding Type used for General Electronic equipment for wire-bonding / die-bonding.

2.MURATA Part NO. System

(Ex.) GMD	03	3	R6	0J	104	K	E11	D
	(1)L/W Dimensions	(2)T Dimensions	(3)Temperature Characteristics	(4)Rated Voltage	(5)Nominal Capacitance	(6)Capacitance Tolerance	(7)Murata's Control Code	(8)Packaging Cod

3. Type & Dimensions



(Unit:mm)

1

(1)-1 L	(1)-2 W	(2) T	е	g
0.6±0.03	0.3±0.03	0.3±0.03	0.12 to 0.22	0.16 min.

4.Rated value

(3) Temperature Characteristics (Public STD Code):X5R(EIA)		(4) Rated	(5) Nominal	(6) Capacitance	Specifications and Test Methods	
Temp. coeff or Cap. Change	Temp. Range (Ref.Temp.)	Voltage	Capacitance	Tolerance	(Operating Temp. Range)	
-15 to 15 %	-55 to 85 °C (25 °C)	DC 6.3 V	0.1 uF	±10 %	-55 to 85 °C	

5.Package

	on acrage						
mark	(8) Packaging	Packaging Unit					
D	φ180mm Reel PAPER W8P2	15000 pcs./Reel					
J	φ330mm Reel PAPER W8P2	50000 pcs./Reel					

Product specifications in this catalog are as of Aug.9,2016,and are subject to change or obsolescence without notice. Please consult the approval sheet before ordering.

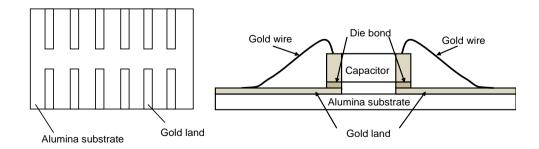
Please read rating and !Cautions first.

■SPECIFICATIONS AND TEST METHODS

No	Ite	m	Specification	Test Method				
1	Operating		B1,B3 : -25°C to +85°C	Reference Temperature : 20°C(R6 :25°C)				
	Temperature Range		R6:-55°C to +85°C					
2	Rated Voltage		See the previous pages.	The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor. When AC voltage is superimposed on DC voltage, V ^{P-P} or V ^{O-P} , whichever is larger, should be maintained within the rated voltage range.				
3	Appearance		No defects or abnormalities.	Visual inspection.				
	Dimension			<u>'</u>				
			Within the specified dimensions.	Using calipers.				
5	Dielectric Streng	gtn	No defects or abnormalities.	No failure should be observed when 250% of the rated voltage is applied between the terminations for 1 to 5 seconds, provided the charge/discharge current is less than 50mA.				
6	Insulation Resistance		More than 50Ω∙F	The insulation resistance should be measured with a DC voltage not exceeding the rated voltage at 20°C/25°C and 75%RH max. and within 1 minutes of charging, provided the charge/discharge current is less than 50mA.				
7	Capacitance		Within the specified tolerance.	The capacitance/D.F. should be measured at 20°C/25°C at the frequency and voltage shown in the table.				
8	Dissipation Fact	or	B1,B3,R6: 0.1max	Capacitance Frequency Voltage				
	(D.F.)			C≦10uF(10V min.)*1 1±0.1kHz 1.0±0.2Vrms				
				C≦10uF(6.3V min.) 1±0.1kHz 0.5±0.1Vrms				
				*1 : GMD155 B3/R6 1A 124 to 224 are applied to 0.5+/-0.1Vrms				
9	Capacitance Temperature Characteristics	No bias	B1, B3 : Within ±10% (-25 to +85°C) R6 : Within ±15% (-55 to +85°C)	The capacitance change sholud be measured after 5 min. at each specified temp. stage. The ranges of capacitance change compared with Reference Temperature value over the temperature ranges shown in the table should be within the specified ranges. *				
				Step Temperature(°C) Applying Voltage(V) 1 20±2/25±2				
		50% of the Rated Voltage	B1 : Within +10/-30%	2 -55±3(for R6) / -25±3(for B1,B3) 3 20±2/25±2 4 85±3(for B1,B3,R6)				
				5 20±2/25±2 6 -25±3(for B1) 50 of the Rated voltage 8 85±3(for B1)				
				* Initial measurement for high dielectric constant type Perform a heat treatment at 150 +0/-10°C for one hour and then set for 24±2 hours at room temperature. Perform the initial measurement.				
10	Mechanical Strength	Bond Strength	Pull force : 0.03N min.	MIL-STD-883 Method 2011 Conition D Mount the capacitor on a gold metallized alumina substrate with Au-Sn(80/20) and bond a 25µ m(0.001 inch) gold wire to the capacitor terminal using an ultrasonic ball bond. Then, pull wire.				
		Die Shear Strength	Die Shear force : 2N min.	MIL-STD-883 Method 2019 Mount the capacitor on a gold matallized alumina substrate with Au-Sn(80/20). Apply the force parallel to the substrate.				
11	Vibration	Appearance	No defects or abnormalities.	The Capacitor should be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied				
		Capacitance	Within the specified tolerance.	uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz,				
		D.F.	B1,B3,R6 : 0.1max	should be traversed in approximately 1 minute. This motion should be applied for a period of 2 hours in each 3 mutually perpendicular directions (total of 6 hours).				

No	I	Item	Specification			Test Metho	od			
12	Temperatu	re	The measured and observed characteristics should	Fix	the cap	acitor to the supporting jig in	the same manner a	and		
	Sudden		satisfy the specifications in the following table.	under the same conditions as (11) and conduct the five cycles						
	Change Appearance		No defects or abnormalities.	according to the temperatures and time shown in the following to			ing table.			
					Set for 24±2 hours at room temperature, then measure.					
		Capacitance	B1,B3, R6 : Within ±7.5%		Step	Temp.(°C)	Time (min.)			
		Change			1	Min. Operating Temp.+0/-3	30±3			
					2	Room Temp	2 to 3			
		D.F.	B1,B3, R6 : 0.1max.		3	Max. Operating Temp.+3/-0	30±3			
					4	Room Temp	2 to 3			
		I.R.	More than 50Ω •F	- 1	nitial me	easurement				
				Per	Perform a heat treatment at 150+0/-10 °C for one hour and then set					
		Dielectric	No defects.	for 2	24±2 ho	ours at room temperature.				
		Strength		Per	form the	e initial measurement.				
13	High Temp	erature	The measured and observed characteristics should	App	ly the ra	ated voltage for 500±12 hou	rs at 40±2°C, in 90) to 95%		
	High Humid	dity	satisfy the specifications in the following table.	hun	nidity an	d set is for 24±2 hours at ro	om temperature, th	ien		
	(Steady)	Appearance	No defects or abnormalities.	measure. The charge/discharge current is less than 50mA.						
		Capacitance	B1,B3, R6: Within ±12.5%	• Ini	tial mea	surement				
		Change		Perform a heat treatment at 150+0/-10°C for one hour and then let						
		D.F. B1,B3, R6 : 0.2max.				sit for 24±2 hours at room temperature. Perform the initial				
				measurer		measurement.				
				Measurement after test						
		I.R.	More than 12.5Ω ∙F	Per	form a h	neat treatment at 150+0/-10 °	C for one hour and	then let		
		Towns and the latest		sit for 24±2 hours at room temperature, then measure.						
14	High Temp	erature	The measured and observed characteristics should		•	6 of the rated voltage for 1000				
	Load		satisfy the specifications in the following table.	1		perating temperature ±3°C. I	Let sit for 24±2 ho	urs at		
		Appearance	No defects or abnormalities.		•	erature, then measure.	- 50 · · A			
		Conocitors	D4 D2 D6: Within ±42 59/	ine	cnarge	discharge current is less tha	n amma.			
		Capacitance	B1,B3, R6: Within ±12.5%	. 1	itial ac-	acurament				
		Change				asurement neat treatment at 150+0/-10°0	for one bour and	than lat		
		D.F.	B1,B3, R6: 0.2max.			hours at room temperature.		illett let		
		D.F.	1,03, No. 0.2111dX.		asureme	·	. Chomi the initial			
		I.R.	More than 25Ω •F	. N.A.	aguram	nent after test				
		1	11010 11411 2012 1			neat treatment at 150+0/-10 °	C for one hour and	then let		
						2 hours at room temperature,		uigii iet		
]		oit I	UI 24-1	L nours at room temperature,	uicii iiicasuic.			

Mounting for testing: The capacitors should be mounted on the substrate as shown below using die bonding and wire bonding when tests No.11 to 14 are performed.



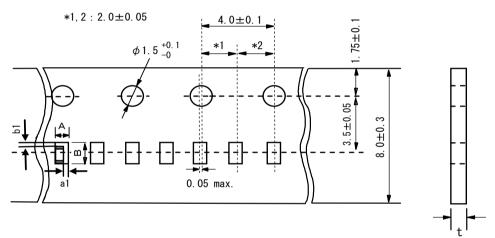
1.Tape Carrier Packaging(Packaging Code:D/E/W/J/F)1.1 Minimum Quantity(pcs./reel)

	φ180m	φ330mm reel	
Туре	Paper	Paper Tape	
	Code:D/E	Code:W	Code:J/ F
GMD03	15000(W8P2)	30000(W8P1)	50000(W8P2)
GMD15	10000(W8P2)	20000(W8P1)	50000(W8P2)

1.2 Dimensions of Tape

(1) GMD03/15(W8P2 CODE:D/E/J/F)

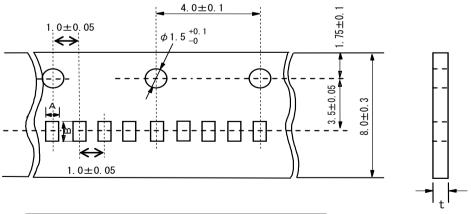
(in mm)



Code	GMD03	GMD15
A *3	0.37	0.65
B *3	0.67	1.15
t	0.5 max.	0.8 max.

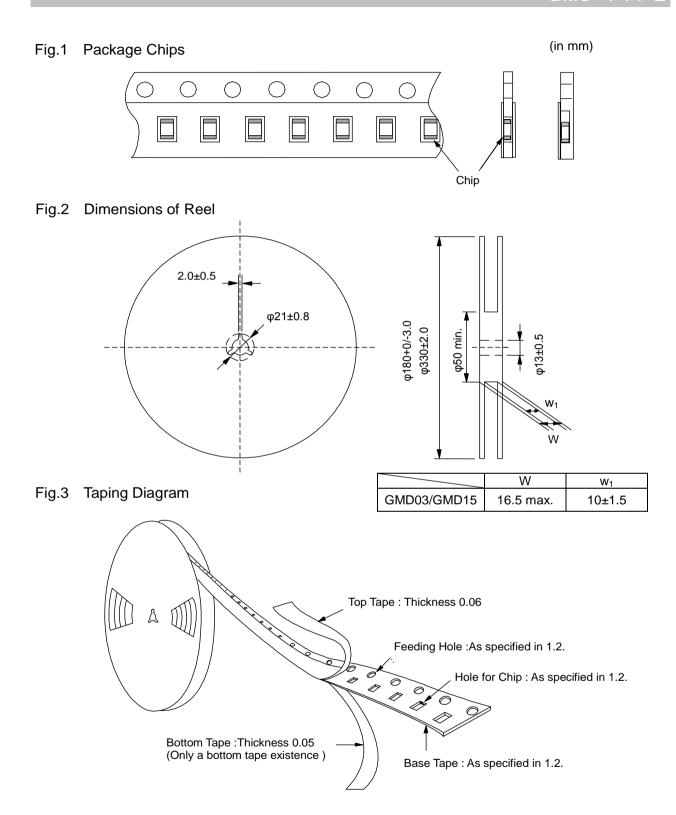
*3 Nominal value

(2)GMD03/15(W8P1 CODE:W)

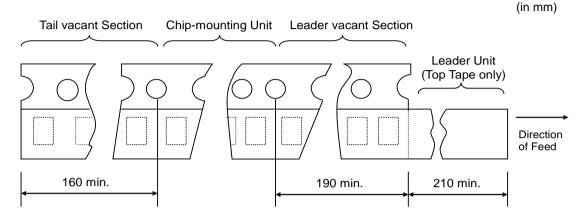


Code	GMD03	GMD15
A *3	0.37	0.65
B *3	0.67	1.15
t	0.5 max.	0.8 max.

*3 Nominal value



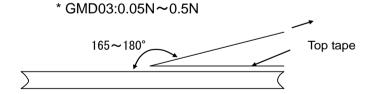
- 1.3 Tapes for capacitors are wound clockwise shown in Fig.3. (The sprocket holes are to the right as the tape is pulled toward the user.)
- 1.4 Part of the leader and part of the vacant section are attached as follows.



- 1.5 Accumulate pitch : 10 of sprocket holes pitch = 40 ± 0.3 mm
- 1.6 Chip in the tape is enclosed by top tape and bottom tape as shown in Fig.1.
- 1.7 The top tape and base tape are not attached at the end of the tape for a minimum of 5 pitches.
- 1.8 There are no jointing for top tape and bottom tape.
- 1.9 There are no fuzz in the cavity.
- 1.10 Break down force of top tape : 5N min.

 Break down force of bottom tape : 5N min. (Only a bottom tape existence)
- 1.11 Reel is made by resin and appeaser and dimension is shown in Fig 2.

 There are possibly to change the material and dimension due to some impairment.
- 1.12 Peeling off force: 0.1 to 0.6N* in the direction as shown below.



1.13 Label that show the customer part number, our part number, our company name, inspection number and quantity, will be put in outside of reel.

Limitation of use

Please contact our sales representatives or product engineers before using our products for the applications listed below which require of our products for other applications than specified in this product.

- 1)Aircraft equipment 2)Aerospace
 - 2 Aerospace equipment
- 3 Undersea equipment
- 4 Power plant control equipm

- (5)Medical equipment
- (6) Transportation equipment(vehicles.trains.ships.etc.)
- Traffic signal equipment

- ®Disaster prevention / crime prevention equipment
- 9 Data-processing equipment
- (11) Application of similar complexity and/or requirements to the applications listed in the above

Strage and Operation conditions

The performance of chip monolithic ceramic capacitors may be affected by the storage conditions.

- ①Storage environment must be at an ambient temperature of 5-40°C. And an ambient humidity of 20-70% RH. Use chip within 6 months. If 6 months or more have elapsed, check bondability before use.
- ②Insulation Resistance should be deteriorated on specific condition of high humidity or incorrosion gas such as hydrogen sulfide, sulfurous acid gas, cholorine.
- 3Do not directly touch capacitors with hands.

■ Die Bonding of capacitors

Use the following materials

Braze allov:

Au-Sn (80/20) 300 to 320°C in N2 atmosphere

- Mounting
- (1)Control the temperature of the substrate so that it mathes the temperature of the braze alloy.
- ②Place braze alloy on substrate and place the capacitor on the alloy. Hold the capacitor and gently apply the load. Be sure to complete the operation in 1 minute.

■ Wire Bonding

Wire

Gold wire: 25µ m (0.001 inch) diameter

- Bondina
- 1)Thermocompression, ultrasonic ball bonding.
- ②Required stage temperature: 150 to 200°C.
- 2 Required wedge of capillary weight: 0.2N to 0.5N.
- 3)Bond the capacitor and base substrate or other devices with gold wire.

Others

(1) Resin Coating

When selecting resin materials, select those with low contraction.

(2) Circuit Design

GMD Series capacitors in this catalog are not safety recognized products.

Remarks

The above notices are for standard applications and conditions. Contact us when the products are used in special mounting conditions.

Select optimum conditions for operation as they determine the reliability of the product after assembly.

NOTE

- 1.Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. Your are requested not to use our product deviating from this product specification.
- 3.We consider it not appropriate to include any terms and conditions with regard to the business transaction in the product specifications, drawings or other technical documents. Therefore, if your technical documents as above include such terms and conditions such as warranty clause, product liability clause, or intellectual property infringement liability clause, they will be deemed to be invalid.